





giuliano.sisto1@gmail.com → +32 470 13 63 06 → +39 340 41 09 479 • Emile van Arenberghstraat 23, 3000, Leuven, Belgium

ABOUT ME

I am an enthusiastic SoC Researcher, with Physical Design expertise and a keen eye for design methodologies. I thrive in contexts where "what?" is always followed by "how?". Currently, I am looking for a chance to boost my knowledge on Computer Architectures while leveraging my expertise in SoC design. My ambition is to steer the semiconductor industry towards the path of Architecture-Design Co-Optimization, as I strongly believe that it will be a key enabler for next generation digital ICs.

EDUCATION

Doctor of Philosophy (PhD), Electrical Engineering

Ecole polytechnique de Bruxelles – Université Libre de Bruxelles

- Oct 2018 Oct 2021(expected)
- Thesis: "Design Enablement of integrated circuts using sub-5nm technology process and 3D integration"

Exchange Student, Electronic Systems

Department of Electrical Engineering – Technology University of Eindhoven

- **i** Feb 2017 July 2017
- Eindhoven, NL
- Projects: RISC microprocessor design interconnection network modelling for a multicore processor • embedded controller design for automotive (Xilinx FPGA)
- low power RF mixer design

MSc, Electrical Engineering, Micro Electronics Systems

Dipartimento di Ingegneria Elettrica e dell'informazione – Politecnico di Bari

i Jan 2016 – Jul 2018

🛡 Bari. IT

EXPERIENCE

PhD Candidate

Cadence Design Systems - IMEC

- iii Oct 2018 Present
- Leuven. BE
- Proposal and implementation of new methods to enable advanced technologies for front-end and back-end digital IC design
- Advanced CMOS technology nodes (sub-5nm): FinFET GAAFET CFET
- 3D-IC: Face-to-Face Hybrid Bonding stacking
- Industrial design benchmarking: ARM RISC-V NVDLA

Engineering Internship

Huawei Technologies

- 苗 Feb 2018 Jul 2018
- Sophia-Antipolis, FR
- Architecture design and physical implementation of digital filters for All Digital

Event organizing team

Devlounge

- **i** Sep 2016 Nov 2016
- Bari, IT
- Technical support to comics convention: Hardware management Ordering service

TECHNICAL SKILLS

TCL Bash Linux Verilog, VHDL

Python Git Matlab



SOFT SKILLS

Resilience | Problem solving Project management Empathy \ Affinity to learn Team player Public Speaking/Presenting

LANGUAGES

Italian English French Dutch



AWARDS

♀ ERASMUS+ for Traineeship Scholarship

TUCEP

2018

Bari,IT

♀ ERASMUS+ Scholarship

2017

Bari.IT

INTERESTS

Politecnico di Bari

Videogames | Board/Card games eSports) Football Cinema Travel Music

LIST OF PUBLICATIONS

- G.Sisto, P. Debacker, R. Chen, G. Van der Plas, R. Chou, E. Beyne, D. Milojevic, "Design enablement of fine pitch face-to-face 3D system integration using die-by-die place & route", 3DIC 2019, Sendai, Japan
- G.Sisto et al., "IR-Drop Analysis of Hybrid Bonded 3D-ICs with Backside Power Delivery and μ- & n- TSVs", IITC 2021, Kyoto, Japan